

C3D03060F Silicon Carbide Schottky Diode

Z-REC[®] RECTIFIER (Full-Pak)

Features

- 600-Volt Schottky Rectifier
- Zero Reverse Recovery Current
- Zero Forward Recovery Voltage
 High-Frequency Operation
- High-Frequency Operation
- Temperature-Independent Switching Behavior
- Extremely Fast Switching
- Positive Temperature Coefficient on V_F

Benefits

- Replace Bipolar with Unipolar Rectifiers
- Essentially No Switching Losses
- Higher Efficiency
- Reduction of Heat Sink Requirements
- Parallel Devices Without Thermal Runaway

Applications

- Switch Mode Power Supplies (SMPS)
- Boost diodes in PFC or DC/DC stages
- Free Wheeling Diodes in Inverter stages
- AC/DC converters

Maximum Ratings ($T_c = 25$ °C unless otherwise specified)

Symbol	Parameter	Value	Unit	Test Conditions	Note
V _{RRM}	Repetitive Peak Reverse Voltage	600	V		
V _{DC}	DC Blocking Voltage	600	V		
I _F	Continuous Forward Current	8 3 2	A	T _c =25°C T _c =145°C T _c =160°C	Fig. 3
I _{frm}	Repetitive Peak Forward Surge Current	11 6	А	$T_c=25$ °C, t _p =10 mS, Half Sine Wave $T_c=110$ °C, t _p =10 mS, Half Sine Wave	
\mathbf{I}_{FSM}	Non-Repetitive Peak Forward Surge Current	18 14.5	А	$T_c=25$ °C, t _p =10 mS, Half Sine Wave $T_c=110$ °C, t _p =10 mS, Half Sine Wave	Fig. 8
$\mathrm{I}_{_{FSM(Max)}}$	Non-Repetitive Peak Forward Surge Current	100 80	А	$T_c=25$ °C, t_P=10 µS, Pulse $T_c=110$ °C, t_P=10 µS, Pulse	Fig. 8
P_{tot}	Power Dissipation	27.3 11.8	W	T _c =25°C T _c =110°C	Fig. 4
dV/dt	Diode dV/dt ruggedness	200	V/ns	V _R =0-600V	
∫i²dt	i²t value (Per Leg)	1.6 1.0	A²s	$T_c=25^{\circ}C, t_p=10 \text{ ms}$ $T_c=110^{\circ}C, t_p=10 \text{ ms}$	
T_{j} , T_{stg}	Operating Junction and Storage Temperature	-55 to +175	°C		
	TO-220 Mounting Torque	1 8.8	Nm lbf-in	M3 Screw 6-32 Screw	



 $I_{r}(T_{c}=145^{\circ}C) =$

=

V_{RRM}

Package

TO-220-F2



Marking

C3D03060

600 V

3 A

TO-220-F2



Part Number

C3D03060F

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Electrical Characteristics

Symbol	Parameter	Тур.	Max.	Unit	Test Conditions	Note
V _F	Forward Voltage	1.5 1.8	1.7 2.4	V	$I_{F} = 3 \text{ A } T_{J} = 25^{\circ}\text{C}$ $I_{F} = 3 \text{ A } T_{J} = 175^{\circ}\text{C}$	Fig. 1
I _R	Reverse Current	4 8	20 80	μA	$V_{R} = 600 V T_{J} = 25^{\circ}C$ $V_{R} = 600 V T_{J} = 175^{\circ}C$	Fig. 2
Q _c	Total Capacitive Charge	7.6		nC	$V_{R} = 400 \text{ V}, I_{F} = 3\text{A}$ $di/dt = 500 \text{ A}/\mu\text{S}$ $T_{J} = 25^{\circ}\text{C}$	Fig. 5
С	Total Capacitance	166 14 11		pF	$ \begin{array}{l} V_{_R} = 0 \ V, \ T_{_J} = 25 \ ^\circ C, \ f = 1 \ MHz \\ V_{_R} = 200 \ V, \ T_{_J} = 25 \ ^\circ C, \ f = 1 \ MHz \\ V_{_R} = 400 \ V, \ T_{_J} = 25 \ ^\circ C, \ f = 1 \ MHz \end{array} $	Fig. 6
E _c	Capacitance Stored Energy	1.1		μJ	V _R = 400 V	Fig. 7

Note: This is a majority carrier diode, so there is no reverse recovery charge.

Thermal Characteristics

Symbol	Parameter	Тур.	Unit	Note
$R_{_{ ext{ hetaJC}}}$	Thermal Resistance from Junction to Case	5.5	°C/W	Fig. 9

Typical Performance



Figure 1. Forward Characteristics





Typical Performance



Figure 5. Total Capacitance Charge vs. Reverse Voltage



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Typical Performance



Figure 7. Capacitance Stored Energy



Figure 8. Non-repetitive peak forward surge current versus pulse duration (sinusoidal waveform)



Figure 9. Transient Thermal Impedance



Package Dimensions

Package TO-220-F2



SYMBOL	MIN (mm)	MAX (mm)			
А	4.30	4.93			
A1	1.80	3.90			
A2	2.34	2.90			
b	0.40	0.91			
b1	1.00	1.40			
b2	0.56	0.93			
b3	0.24	0.55			
С	0.40	0.80			
D	14.70	16.07			
D1	2.50 TYP				
D2	2.	66 TYP			
е	4.83	5.33			
E	9.70	10.36			
E1	7.	00 TYP			
G	6.50	7.10			
Но		28 TYP			
L	12.10	13.50			
L1		0.50			
М	2.	2.86 TYP			
ØР	2.98	3.40			
Q	3.10	3.30			
Q1	2.70	3.50			
Θ	20° TYP				
Θ1	3° TYP				
Θ2	5° TYP				



Recommended Solder Pad Layout



TO-220-2

Part Number	Package	Marking	
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Note: Recommended soldering profiles can be found in the applications note here: http://www.cree.com/power_app_notes/soldering

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Notes

• RoHS Compliance

The levels of RoHS restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU Directive 2011/65/EC (RoHS2), as implemented January 2, 2013. RoHS Declarations for this product can be obtained from your Wolfpseed representative or from the Product Ecology section of our website at http://www.wolfspeed.com/Power/Tools-and-Support/Product-Ecology.

• **REACh Compliance**

REACh substances of high concern (SVHCs) information is available for this product. Since the European Chemical Agency (ECHA) has published notice of their intent to frequently revise the SVHC listing for the foreseeable future, please contact a Cree representative to insure you get the most up-to-date REACh SVHC Declaration. REACh banned substance information (REACh Article 67) is also available upon request.

This product has not been designed or tested for use in, and is not intended for use in, applications implanted into
the human body nor in applications in which failure of the product could lead to death, personal injury or property
damage, including but not limited to equipment used in the operation of nuclear facilities, life-support machines,
cardiac defibrillators or similar emergency medical equipment, aircraft navigation or communication or control
systems, or air traffic control systems.

Related Links

- Cree SiC Schottky diode portfolio: http://www.wolfspeed.com/Power/Products#SiCSchottkyDiodes
- Schottky diode Spice models: http://www.wolfspeed.com/power/tools-and-support/DIODE-model-request2
- SiC MOSFET and diode reference designs: http://go.pardot.com/l/101562/2015-07-31/349i

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